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SerDes FIN224C 24-Bit Low-Power Serializer/Deserializer

Features

Data & Control Bits	24
Frequency	20MHz
Capability	HVGA
Interface	Microcontroller / RGB
µController Usage	l86 & m68
Dynamic Current	17mA at 10Mhz
Standby Current	10µA
Core Voltage (V _{DDA/S})	2.5V to 3.3V
I/O Voltage (V _{DDP})	1.65V to 3.6V
ESD	15KV (IEC)
Package	MLP-40 (6 x 6mm)
Ordering Information	FIN224CMLX, MLP-40

Related Resources

• For samples and questions, please contact: interface@fairchildsemi.com.

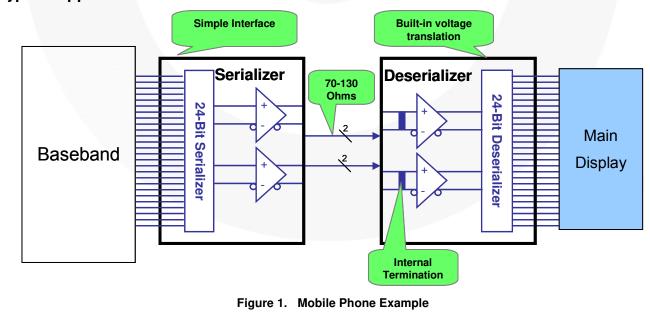
Description

The FIN224C μ SerDesTM is a low-power serializer/ deserializer (μ SerDesTM) that can help minimize the cost and power of transferring wide signal paths. Through the use of serialization, the number of signals transferred from one point to another can be significantly reduced. Typical reduction is 5:1 for unidirectional paths. Through the use of differential signaling, shielding and EMI filters can also be minimized, further reducing the cost of serialization.

The differential signaling is also important for providing a noise-insensitive signal that can withstand radio and electrical noise sources. Major reduction in power consumption allows minimal impact on battery life in mobile applications. It is possible to use a single Phase-Locked Loop (PLL) for most applications, including bi-directional operation.

Applications

- Slider, Folder, and Clamshell Mobile Handsets
- GSM and CDMA Phones



Typical Application

October 2009

Pin Configuration

Pin Name	Description			
STROBE	LVCMOS Strobe Signal for Latching Data into the Serializer (On Rising Edge)			
CKREF	LVCMOS Clock Input and PLL Reference	LVCMOS Clock Input and PLL Reference		
CKP	LVCMOS Word Clock Output			
DP[24:1]	LVCMOS Data I/O			
/DIRO	LVCMOS Control Output Inversion of DIRI			
S1, S2	LVCMOS Select Pins, Controls the Mode of Operation, see Tab	LVCMOS Select Pins, Controls the Mode of Operation, see Table 1		
DIRI	LVCMOS Control, Solooto Sorializar ar Deparializar Mada	0 Deserializer		
DIRI	LVCMOS Control, Selects Serializer or Deserializer Mode	1 Serializer		
DSO+ / DSI-	Serial Data I/O			
DSO- / DSI+				
CKSI+, CKSI-	Serial Clock Input			
CKSO+, CKSO-	Serial Clock Output	Serial Clock Output		
VDDP	Power Supply for Parallel I/O and Internal Circuitry			
VDDS	Power Supply for Serial I/O			
VDDA	Power Supply for Core			
GND	Ground Pins			

Note:

1. $0 = V_{IL}; 1 = V_{IH}.$

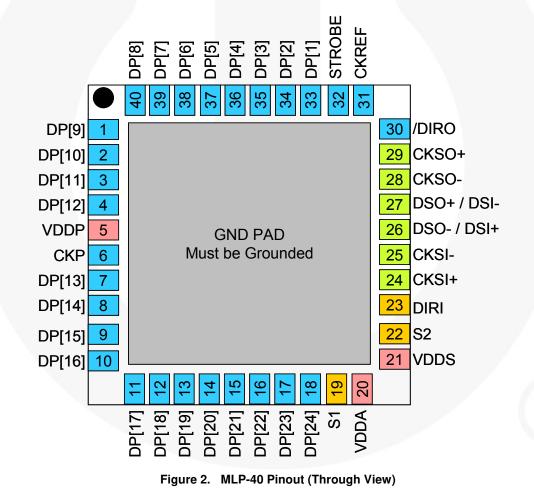
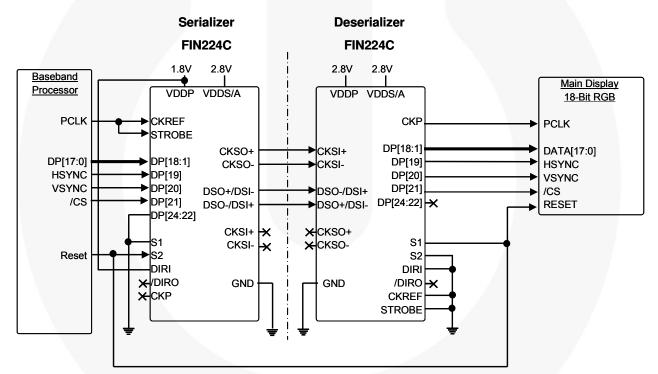


Table 1. Seri	able 1. Serializer / Deserializer, Operation, and Reset Modes					
DIRI	S1	S1 S2 Mode of Operation				
x	0	0	Reset Mode LVCMOS Outputs = High Impedance LVCMOS Inputs = Known State			
1	0	1	Serializer Mode			
0	1	0	Deserializer Mode			

Application Diagrams





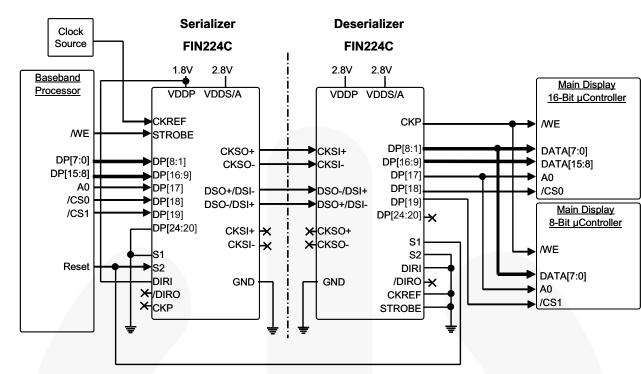


Figure 4. Dual-Display µController Interface Block Diagram

Additional Application Information

Flex Cabling: The serial I/O information is transmitted at a high serial rate. Care must be taken implementing this serial I/O flex cable. The following best practices should be used when developing the flex cabling or Flex PCB.

- Keep all four differential serial wires the same length.
- Do not allow noisy signals over or near differential serial wires. Example: No CMOS traces over differential serial wires.
- Design goal of 70 to 130Ω differential characteristic impedance.
- Do not place test points on differential serial wires.
- Design differential serial wires a minimum of 2cm away from the antenna.
- Visit Fairchild's website at <u>http://www.fairchildsemi.com/products/interface/userdes.html</u>, contact your sales representative, or contact Fairchild directly at <u>interface@fairchildsemi.com</u> for applications notes or flex guidelines.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Unit
V _{DD}	Supply Voltage		-0.5	+4.6	V
	All Input/Output Voltage		-0.5	+4.6	V
T _{STG}	Storage Temperature Range	Storage Temperature Range		+150	°C
TJ	Maximum Junction Temperature		+150	°C	
TL	Lead Temperature (Soldering, 4 Seco		+260	°C	
	IEC 61000 Board Level			15.0	
ESD		All Pins		2.5	kV
	Human Body Model, JESD22-A114	Serial I/0, /RES, PAR/SPI to GND		8.0	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
$V_{DDA}, V_{DDS}^{(1)}$	Supply Voltage	2.5	3.3	V
V _{DDP}	Supply Voltage	1.65	3.60	V
T _A	Operating Temperature	-30	+70	°C

Note:

1. V_{DDA} and V_{DDS} supplies must be hardwired together to the same power supply.

Electrical Specifications

Values valid for over supply voltage and operating temperature ranges unless otherwise specified. Typical values are tested at $T_A = 25^{\circ}C$ and $V_{DD} = 2.775V$.

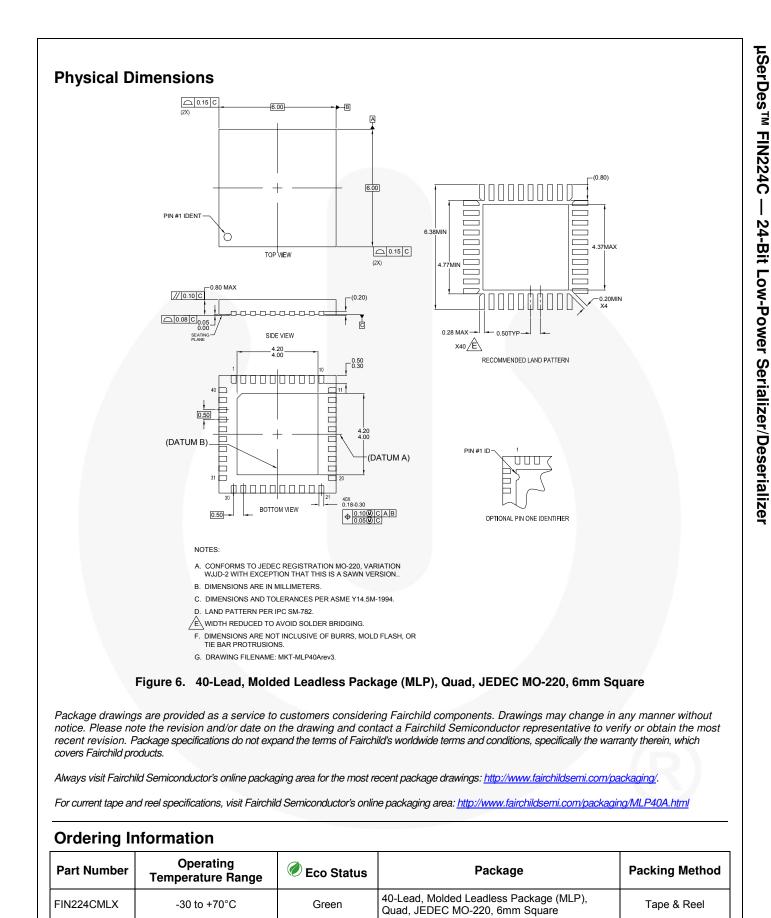
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit	
DC Parallel	I/O Characteristics	•			•		•	
VIH	Input High Voltage				0.65 x V _{DDP}		V _{DDP}	V
VIL	Input Low Voltage				GND		0.35 x V _{DDP}	V
			V _{DDP} = 3.3±	±0.30V				
V _{OH}	Output High Voltage	I _{OH} = -2.0mA	V _{DDP} = 2.5±	$V_{DDP} = 2.5 \pm 0.20 V$				V
			V _{DDP} = 1.8±	£0.18V				
			V _{DDP} = 3.3±	V _{DDP} = 3.3±0.30V				
Vol	Output Low Voltage	I _{OH} = -2.0mA	V _{DDP} = 2.5	±0.20V			0.25 x V _{DDP}	V
			V _{DDP} = 1.8±	£0.18V				
I _{IN}	Input Current	·			-5		5	μA
DC Serial C	haracteristics							
I _{ODH}	Output High Source Current					-1.75		mA
I _{ODL}	Output Low Source Current					0.95		mA
l _{oz}	Disabled Output Leakage Current	CKSO, DSO = 0 S2 = S1 = 0V)V to V _{DDS} ,			±1	±5	μA
I _{IZ}	Disabled Input Leakage Current	CKSO, DSO = 0 S2 = S1 = 0V)V to V _{DDS} ,			±1	±5	
R _{TRM}	CKSI, DS Internal Receiver Termination	on Resistor				100		Ω
Z	Serial Transmission Line Impedance				70	100	130	Ω
Power Char	racteristics							
IDDA/S _{SER}	V _{DDA} , V _{DDS} Serializer Static Current	All DP and Cont CKREF, DIRI =		V or No		4.5		mA
IDDA/S _{DES}	V _{DDA} , V _{DDS} Derializer Static Current	All DP and Control Inputs at 0V or No CKREF, DIRI = 0			5		mA	
	Dynamic Serializer Current			10MHz		11		mA
IDD _{SER}	IDD _{SER} = IDDA + IDDS + IDDP	CKREF = STRC	BE, DIRI = 1	20MHz		15		mA
ססו	Dynamic Deserializer Current	CKREF = STROBE, DIRI = 0			7		mA	
IDD _{DES}	IDD _{SER} = IDDA + IDDS + IDDP	CKREF = STRC	BE, DIRI = 0	20MHz		10		mA
IDD_PD	V _{DD} Power-Down Current IDD_PD = IDDA + IDDS + IDDP	S1 = S2 = 0 All	Inputs at GND	or V _{DD}		0.1		μA
AC Serialize	er, DIRI = 1 Specifications							
f _{MAX}	Maximum CKREF Frequency	ICLKT	← →	- tCLKT	2		20	MHz
f _{REF}	CKREF Frequency Relative to	1 /	490% 90%		1.1 x f _{STROBE}		20	MHz
t _{срwн}	STROBE CKREF Clock HIGH Time		, 10	»%¥	0.2	0.5	B	т
t _{CPWL}	CKREF Clock LOW Time	-	- tTCP		0.2	0.5		т
t _{CLKT}	LVCMOS Input Transition Time	CKREF 50%		50%			90	ns
t _{spwн}	STROBE Pulse Width HIGH/LOW	tcp			(Tx4) / 26		(Tx22) / 26	ns
tsтc	DP[n] Setup to STROBE		→ → ←	t _{HTC}	2.5			ns
t _{HTC}	DP[n] Hold to STROBE	DP[24:1]	$\ddagger 1$	$\overline{\chi}$	2.0			ns

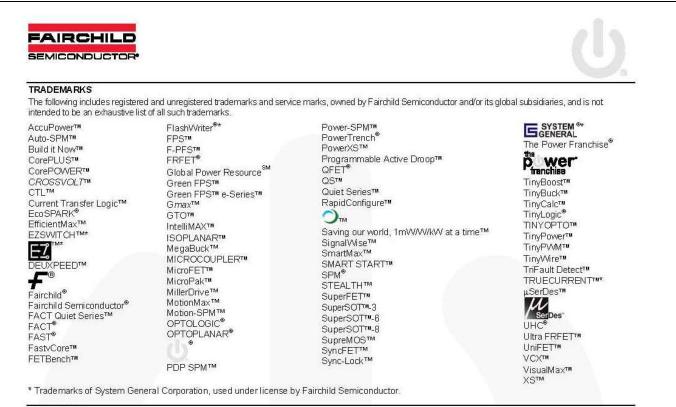
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{TPLLS0}	Phase Lock Loop Stabilization Time	VDD/VDDA S1 or S2 CKREF CKS0			200	μs
t _{TPLLD0}	PLL Disable Time Loss of Clock				30	μs
AC Deseria	lizer, DIRI = 0 Specifications					
t _{sкew_ds-} скs	Allowed DS-CKS Input Signal Skew		-150		150	ps
t _{RCOH}	CKP Out Low Time	Data Time CKP DP[1:12] Data	13a-3		13a+3	ns
t _{RCOH}	CKP Out High Time	CKREF 50%	13a-3		13a+13	ns
t _{PDV}	Data Valid to CKP Low	CKREF = STROBE, a = (1/f)/13	8a-6		8a+1	ns
t _{rolh}	Output Rise Time (20% to 80%)	tROLH - + + + + + + + ROHL DPn 20%		18		ns
trolh	Output Fall Time (20% to 80%)	DPn BpF		18		ns
AC Enable	and Disable Timing					
t _{PLZ(HZ)}	Deserializer Disable Time	S1 or S2			25	ns
t _{PZL(ZH)}	Deserializer Enable Time	DP			2	μs
t _{PLZ(HZ)}	Serializer Disable Time	S1 or S2			25	ns
t _{PZL(ZH)}	Serializer Enable Time	DS+,CKS0+			65	ns

Notes:

2. Skew is measured from either the rising or falling edge of CKSO clock to the rising or falling edge of DSO. Signals are edge aligned. Both outputs should have identical load conditions for this test to be valid.

3. If CKREF is not equal to STROBE for the serializer, the CKP signal does not maintain a 50% duty cycle. The low time of CKP remains 13 bit times.





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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
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Rev. 143

µSerDes[™] FIN224C

24-Bit Low-Power Serializer/Deserializer

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